



WG7833BEM2A M.2 Type2226 Module

TI WL1833 IEEE 802.11a/b/g/n solution

BT/BLE Solution

Datasheet

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1. OVERVIEW

WG7833BEM2A, a WiFi, BT, BLE combo module, is the most demanded design for mobile devices, Audio, Computer, and embedded system applications with Wilink8 solution from TI.

1.1. General Features

- WLAN, Bluetooth, BLE, ANT with Integrated RF Front-End Module (FEM), Power Amplifier (PA), and Power Management on a Single Module
- M.2 Type2226 LGA package
- Dimension 26mm(L) x 22.0mm(W) x 2.6mm(H)
- Provides efficient direct connection to battery by employing several integrated switched mode power supplies (DC2DC).
- Seamless Integration with TI Sitara™ and Other Application Processors
- WLAN and BT/BLE/ANT cores are software and hardware compatible with prior WL127x and WL128x offerings, for smooth migration to device.
- Shared HCI transport for BT/BLE/ANT over UART and SDIO for WLAN.
- Temperature detection and compensation mechanism ensures minimal variation in RF performance over the entire temperature range.
- BT 4.0, BLE, ANT and all audio processing features work in parallel and include full coexistence with WLAN
- Operating temperature: -40°C to 85°C



2. FUNCTIONAL FEATURES

2.1. Module Block Diagram

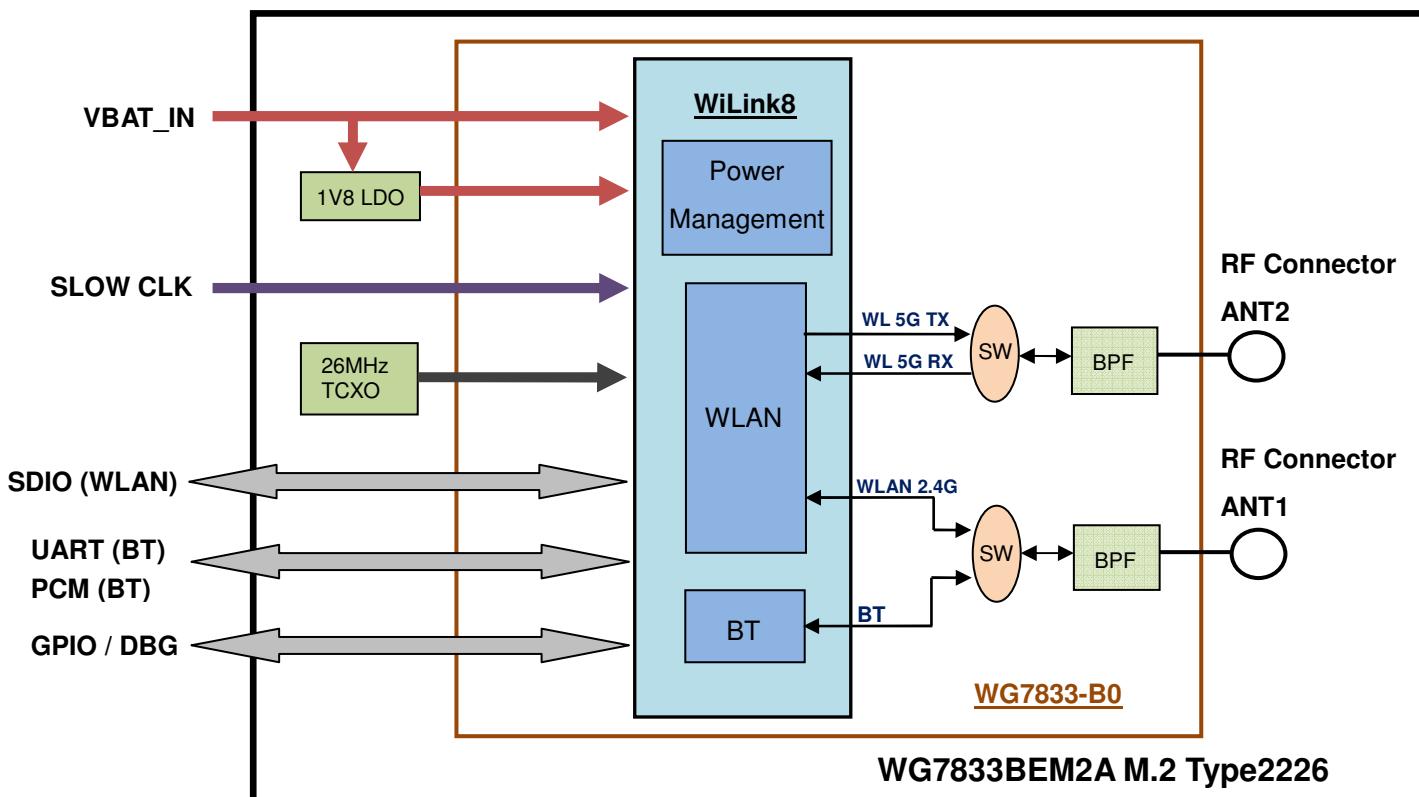


Figure 2-1 WG7833BEM2A Block Diagram

2.2. Block Functional Feature

2.2.1. WLAN Features

- Integrated 2.4 & 5G GHz Power Amplifier (PA) for WLAN solution
- WLAN Baseband Processor and RF transceiver Supporting IEEE Std 802.11a/b/g/n
- WLAN 2.4/5 GHz SISO (20/40 MHz channels)
- Baseband Processor
 - IEEE Std 802.11a/b/g/n data rates and IEEE Std 802.11n data rates with 20 or 40 MHz SISO.
- Fully calibrated system. Production calibration not required.
- Medium Access Controller (MAC)
 - Embedded ARM™ Central Processing Unit (CPU)
 - Hardware-Based Encryption/Decryption using 64-, 128-, and 256-Bit WEP, TKIP or AES Keys,
 - Supports requirements for Wi-Fi Protected Access (WPA and WPA2.0) and IEEE Std 802.11i [includes hardware-accelerated Advanced Encryption Standard (AES)]
 - Designed to work with IEEE Std 802.1x
- IEEE Std 802.11d, e, h, i, k, r PICS compliant.
- New advanced co-existence scheme with BT/BLE/ANT.
- 2.4/5 GHz Radio
 - Internal LNA and PA
 - Supports: IEEE Std 802.11a, 802.11b, 802.11g and 802.11n
- Supports 4 bit SDIO host interface, including high speed (HS) and V3 modes.

2.2.2. Bluetooth Features

- Supports Bluetooth 4.0 as well as CSA2
- Includes concurrent operation and built -in coexisting and prioritization handling of Bluetooth, BLE, ANT, audio processing and WLAN
- Dedicated Audio processor supporting on chip SBC encoding + A2DP:
 - Assisted A2DP (A3DP) support - SBC encoding implemented internally
 - Assisted WB-Speech (AWBS) support - modified SBC codec implemented internally

2.2.3. BLE Features

- Fully compliant with BT4.0 BLE dual mode standard
- Support for all roles and role-combinations, mandatory as well as optional
- Supports up to 10 BLE connections
- Independent buffering for LE allows having large number of multiple connections without affecting BR/EDR performance

2.2.4. ANT Features

Fully compliant with all ANT Protocols:

- ANT solution optimized for the fitness and health use-cases
- Simple to complex network topologies
- Supports high-resolution proximity pairing

The ANT protocol has been designed to be very power-efficient, yet is flexible enough to support various network topologies (point-to-point, star, 1-to-N, N-to-1) and data transfer modes (broadcast, broadcast with acknowledge, mass data transfer). Each logical ANT channel can be independently configured for 1-way or 2-way operation

3. MODULE OUTLINE

3.1. Signal Layout (Top View)

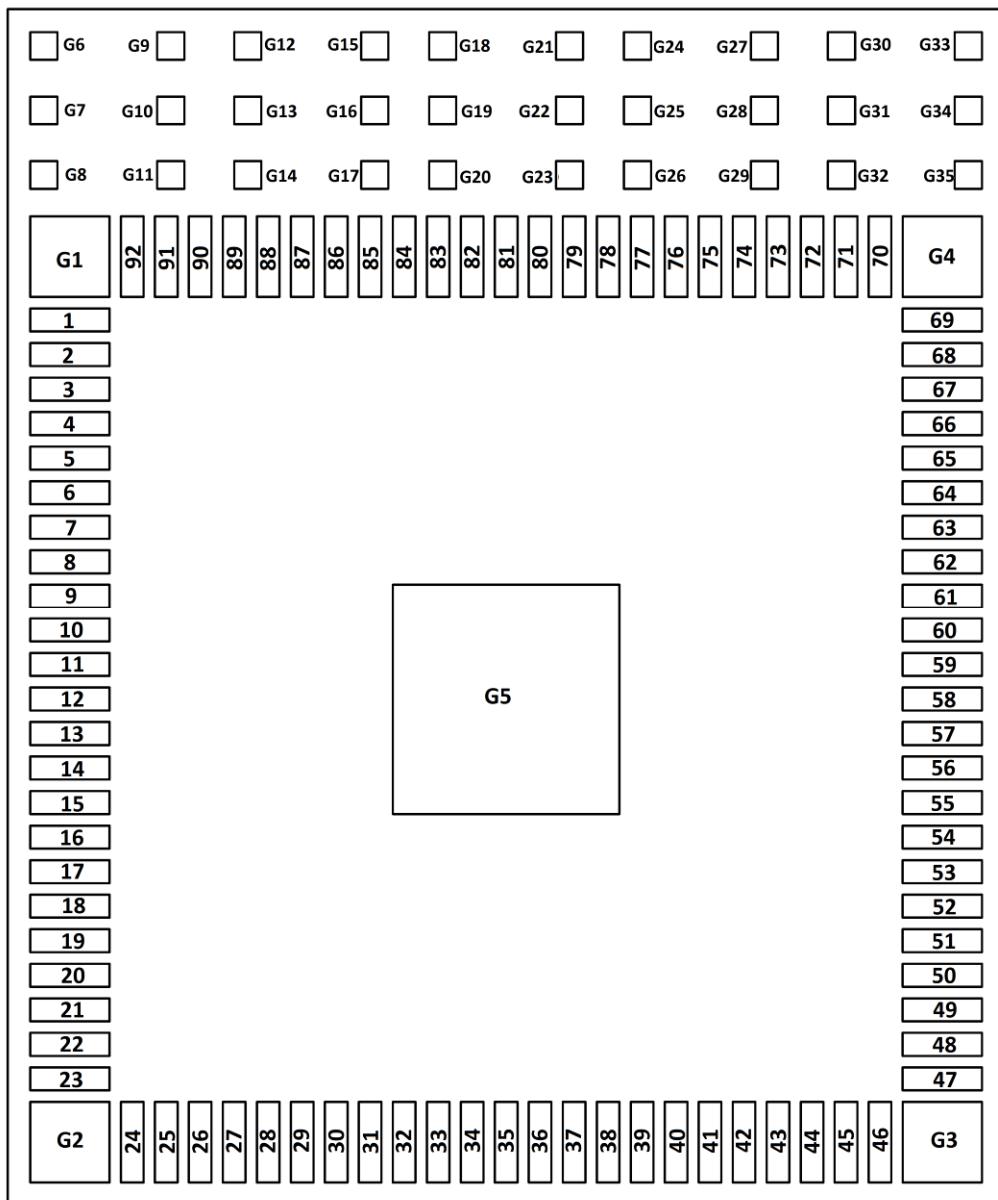


Figure 3-1 Device pins

3.2. Pin Description

Table 3-1. Pin Description

| Pin No. | Signal Name | Type | Shut Down state | After Power Up ⁽¹⁾ | Voltage Level | Description |
|---------|---------------|------|-----------------|-------------------------------|---------------|---------------------------------------|
| 1 | 3.3V | POW | | | VBAT | Power supply input, 2.9 to 4.6 V. |
| 2 | 3.3V | POW | | | VBAT | Power supply input, 2.9 to 4.6 V. |
| 3 | GND | GND | | | | Ground. |
| 4 | RESERVED | - | | | | No connection. |
| 5 | ALERT# | - | | | | No connection. |
| 6 | I2C_CLK | - | | | | No connection. |
| 7 | I2C_DATA | - | | | | No connection. |
| 8 | COEX1 | - | | | | No connection. |
| 9 | COEX2 | - | | | | No connection. |
| 10 | COEX3 | - | | | | No connection. |
| 11 | RESERVED | I/O | PD | PD | 1.8V | WL_RS232_RX. Reserved for debug only. |
| 12 | RESERVED | I/O | PD | PD | 1.8V | WL_RS232_TX. Reserved for debug only. |
| 13 | RESERVED | - | | | | No connection. |
| 14 | GND | GND | | | | Ground. |
| 15 | RESERVED | - | | | | No connection. |
| 16 | RESERVED | - | | | | No connection. |
| 17 | GND | GND | | | | Ground. |
| 18 | RESERVED | - | | | | No connection. |
| 19 | RESERVED | - | | | | No connection. |
| 20 | GND | GND | | | | Ground. |
| 21 | RESERVED | - | | | | No connection. |
| 22 | RESERVED | - | | | | No connection. |
| 23 | GND | GND | | | | Ground. |
| 24 | SLOWCLK_32kHz | ANA | | | 3.3V | Input Sleep clock: 32.768 KHz |
| 25 | W_DISABLE1# | - | | | | No connection. |
| 26 | PEWAKE# | - | | | | No connection. |
| 27 | CLKREQ# | - | | | | No connection. |
| 28 | PERST# | - | | | | No connection. |
| 29 | GND | GND | | | | Ground. |
| 30 | REFCLKn0 | - | | | | No connection. |

| | | | | | | |
|----|----------------|-----|-----|-----|------|--|
| 31 | REFCLKp0 | - | | | | No connection. |
| 32 | GND | GND | | | | Ground. |
| 33 | PETn0 | - | | | | No connection. |
| 34 | PETp0 | - | | | | No connection. |
| 35 | GND | GND | | | | Ground. |
| 36 | PERn0 | - | | | | No connection. |
| 37 | PERp0 | - | | | | No connection. |
| 38 | GND | GND | | | | Ground. |
| 39 | VENDOR DEFINED | - | | | | No connection. |
| 40 | VENDOR DEFINED | - | | | | No connection. |
| 41 | VENDOR DEFINED | - | | | | No connection. |
| 42 | SDIO RESET# | IN | PD | PD | 1.8V | WL_EN, Mode setting: High = enable |
| 43 | SDIO WAKE# | OUT | PD | 0 | 1.8V | SDIO available, interrupt out. Active high. (For WL_RS232_TX/RX pull up at power up) |
| 44 | SDIO DATA3 | IO | HiZ | PU | 1.8V | WLAN SDIO Data bit 3. Changes state to PU at WL_EN or BT_EN assertion for card detects. Later disabled by software during initialization. ⁽²⁾ |
| 45 | SDIO DATA2 | IO | HiZ | HiZ | 1.8V | WLAN SDIO Data bit 2 ⁽²⁾ |
| 46 | SDIO DATA1 | IO | HiZ | HiZ | 1.8V | WLAN SDIO Data bit 1 ⁽²⁾ |
| 47 | SDIO DATA0 | IO | HiZ | HiZ | 1.8V | WLAN SDIO Data bit 0 ⁽²⁾ |
| 48 | SDIO CMD | I/O | HiZ | HiZ | 1.8V | WLAN SDIO Command ⁽²⁾ |
| 49 | SDIO CLK | IN | HiZ | HiZ | 1.8V | WLAN SDIO Clock. Must be driven by the host. |
| 50 | UART WAKE# | OUT | PD | PD | 3.3V | Bluetooth Host Wake. Open Drain, Active Low. Require pull up on the host side. (recommended 15K to 100K) |
| 51 | UART CTS | IN | PU | PU | 1.8V | UART CTS from Host. |
| 52 | UART TX | OUT | PU | PU | 1.8V | UART TX to Host. |
| 53 | UART RX | IN | PU | PU | 1.8V | UART RX from Host. |
| 54 | UART RTS | OUT | PU | PU | 1.8V | UART RTS to Host. |
| 55 | PCMFR1 | OUT | PD | PD | 1.8V | Bluetooth PCM/I2S Bus. Frame sync. |
| 56 | PCMIN | IN | PD | PD | 1.8V | Bluetooth PCM/I2S Bus. Data in. |
| 57 | PCMOUT | OUT | PD | PD | 1.8V | Bluetooth PCM/I2S Bus. Data out. |
| 58 | PCMCLK | OUT | PD | PD | 1.8V | Bluetooth PCM/I2S Bus. Clock. |
| 59 | GND | GND | | | | Ground. |
| 60 | W_DISABLE2# | IN | PD | PD | 3.3V | BT_EN, Mode setting: High = enable |
| 61 | LED2# | - | | | | No connection. |

| | | | | | |
|--------|---------------------|-----|--|------|-----------------------------------|
| 62 | LED1# | - | | | No connection. |
| 63 | RESERVED | - | | | No connection. |
| 64 | GND | GND | | | Ground. |
| 65 | USB_D- | - | | | No connection. |
| 66 | USB_D+ | - | | | No connection. |
| 67 | GND | GND | | | Ground. |
| 68 | 3.3V | POW | | VBAT | Power supply input, 2.9 to 4.6 V. |
| 69 | 3.3V | POW | | VBAT | Power supply input, 2.9 to 4.6 V. |
| 70 | GND | GND | | | Ground. |
| 71 | GND | GND | | | Ground. |
| 72 | GND | GND | | | Ground. |
| 73 | GND | GND | | | Ground. |
| 74 | GND | GND | | | Ground. |
| 75 | GND | GND | | | Ground. |
| 76 | GND | GND | | | Ground. |
| 77 | GND | GND | | | Ground. |
| 78 | GND | GND | | | Ground. |
| 79 | GND | GND | | | Ground. |
| 80 | GND | GND | | | Ground. |
| 81 | GND | GND | | | Ground. |
| 82 | GND | GND | | | Ground. |
| 83 | GND | GND | | | Ground. |
| 84 | GND | GND | | | Ground. |
| 85 | GND | GND | | | Ground. |
| 86 | GND | GND | | | Ground. |
| 87 | GND | GND | | | Ground. |
| 88 | GND | GND | | | Ground. |
| 89 | GND | GND | | | Ground. |
| 90 | UIM_POWER_SRC/GPIO1 | - | | | No connection. |
| 91 | UIM_POWER_SNK | - | | | No connection. |
| 92 | UIM_SWP | - | | | No connection. |
| G1~G35 | GND | GND | | | Ground. |

(1) PU=pull up; PD=pull down.

(2) Host must provide PU for all non-CLK SDIO signals

4. MODULE SPECIFICATION

4.1. General Module Requirements and Operation

4.1.1. Absolute Maximum Ratings⁽¹⁾

| Parameter | Value | Units |
|-------------------------------------|---------------------------|-------|
| VBAT | -0.5 to 4.6 | V |
| Input voltage to Analog pins | -0.5 to 2.1 | V |
| Input voltage to 1.8V digital pins | -0.5 to 2.3 | V |
| Input voltage to 3.3V digital pins | -0.5 to 4.6 | V |
| Operating ambient temperature range | -40 to +85 ⁽²⁾ | °C |
| Storage temperature range | -55 to +125 | °C |
| ESD Stress Voltage ⁽³⁾ | >1000 | V |
| Human Body Model ⁽⁴⁾ | >250 | V |
| Charged Device Model ⁽⁵⁾ | | |

- 1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2) Operating free-air temperature range. The device can be reliably operated for 7 years at ambient of 85°C, assuming 25% active mode and 75% sleep mode (15,400 cumulative active power-on hours).
- 3) Electrostatic discharge (ESD) to measure device sensitivity/immunity to damage caused by electrostatic discharges into device.
- 4) Level listed is the passing level per ANSI/ESDA/JEDEC JS-001. JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process, and manufacturing with less than 500V HBM is possible if necessary precautions are taken. Pins listed as 1000V may actually have higher performance.
- 5) Level listed is the passing level per EIA-JEDEC JESD22-C101E. JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process, and manufacturing with less than 250V CDM is possible if necessary precautions are taken. Pins listed as 250 V may actually have higher performance.

4.1.2. Recommended Operating Conditions

| Parameter | Condition | Sym | Min | Max | Units |
|--|-------------------------------|--------|-------|-------|-------|
| VBAT ⁽¹⁾ | DC supply range for all modes | | 2.9 | 4.6 | V |
| IO high-level input voltage | 1.8V IO | VIH | 1.17 | 1.8 | |
| IO low-level input voltage | 1.8V IO | VIL | 0 | 0.63 | |
| IO high-level input voltage | 3.3V IO | VIH | 2 | 3.3 | |
| IO low-level input voltage | 3.3V IO | VIL | 0 | 0.8 | |
| Enable inputs high-level input voltage | 1.8V IO | VIH_EN | 1.365 | 1.8 | |
| Enable inputs low-level input voltage | 1.8V IO | VIL_EN | 0 | 0.4 | |
| IO high-level output voltage | 3.3V IO | VOH | | 3.3 | |
| IO low-level output voltage | 3.3V IO | VOL | 0 | 0.2 | |
| High-level output voltage(1.8V IO) | @ 4 mA | VOH | 1.35 | 1.8 | |
| | @ 1 mA | | 1.688 | 1.8 | |
| | @ 0.3 mA | | 1.767 | 1.8 | |
| Low-level output voltage(1.8V IO) | @ 4 mA | VOL | 0 | 0.45 | |
| | @ 1 mA | | 0 | 0.112 | |
| | @ 0.09 mA | | 0 | 0.01 | |
| Input transitions time Tr/Tf from 10% to 90% (Digital IO) ⁽²⁾ | | Tr/Tf | 1 | 10 | ns |
| Output rise time from 10% to 90% (Digital pins) ⁽²⁾ | CL < 25 pF | Tr | | 5.3 | ns |
| Output fall time from 10% to 90% (Digital pins) ⁽²⁾ | CL < 25 pF | Tf | | 4.9 | |
| Ambient operating temperature | | | -40 | 85 | °C |
| Maximum power dissipation | WLAN operation | | | 2.8 | W |
| | BT operation | | | 0.2 | |

(1) 4.8V is applicable only for 2.3 years (30% of the time). Otherwise, the maximum VBAT should not exceed 4.3V.

(2) Applies to all Digital lines except SDIO, UART, I2C, PCM and slow clock lines

4.1.3. External Slow Clock Input (SLOW_CLK)

The supported digital slow clock is 32.768 kHz digital (square wave).

| Parameter | Condition | Sym | Min. | Typ. | Max. | Units |
|---|----------------------------|-------|------|---------|--------|-------|
| Input slow clock Frequency | | | | 32.768 | | KHz |
| Input slow clock accuracy (Initial + temp + aging) | WLAN, BT | Tr/Tf | | +/- 250 | +/- 50 | ppm |
| | ANT | | | | | |
| Input Transition time Tr/Tf - 10% to 90% | | Tr/Tf | | | 100 | ns |
| Frequency input duty Cycle | | | 15 | 50 | 85 | % |
| Input Voltage Limits | Square Wave, DC-coupled | Vih | 2 | VBAT | 0.8 | Vpeak |
| | | Vil | 0 | | | |

4.2. WLAN RF Performance

4.2.1. WLAN 2.4-GHz Receiver Characteristics

| Parameter | Condition | Min | Typ | Max | Units |
|---|------------------|------|-------|-------|-------|
| Operation frequency range | | 2412 | | 2484 | MHz |
| Sensitivity 20MHz Bandwidth At < 10% PER limit | 1 Mbps DSSS | - | -95.8 | -92.9 | dBm |
| | 2 Mbps DSSS | - | -92.7 | -90 | |
| | 5.5 Mbps CCK | - | -90.1 | -87.4 | |
| | 11 Mbps CCK | - | -87.4 | -85.2 | |
| | 6 Mbps OFDM | - | -91.5 | -88.7 | |
| | 9 Mbps OFDM | - | -89.9 | -87.2 | |
| | 12 Mbps OFDM | - | -89 | -86.3 | |
| | 18 Mbps OFDM | - | -86.7 | -84 | |
| | 24 Mbps OFDM | - | -83.6 | -80.9 | |
| | 36 Mbps OFDM | - | -80.2 | -77.5 | |
| Max Input Level At < 10% PER limit | 48 Mbps OFDM | - | -76 | -73.3 | dBm |
| | 54 Mbps OFDM | - | -74.4 | -71.9 | |
| | MCS0 MM 4K | - | -89.9 | -86.9 | |
| | MCS1 MM 4K | - | -87.1 | -84.4 | |
| | MCS2 MM 4K | - | -85.4 | -82.7 | |
| | MCS3 MM 4K | - | -82.3 | -79.6 | |
| | MCS4 MM 4K | - | -78.9 | -76.2 | |
| | MCS5 MM 4K | - | -74.7 | -72 | |
| | MCS6 MM 4K | - | -73 | -70.3 | |
| | MCS7 MM 4K | - | -71.9 | -69.2 | |
| Adjacent channel rejection Sensitivity level +3dB for OFDM, Sensitivity level +6dB for 11b | MCS0 MM 4K 40MHz | - | -86.9 | -82.2 | dBm |
| | MCS7 MM 4K 40MHz | - | -68.5 | -65 | |
| | OFDM(11g/n) | -19 | -9 | | |
| LO Leakage | CCK | -4 | -0 | | dBm |
| | 2Mbps DSSS | 42.7 | | | |
| | 11Mbps CCK | 37.9 | | | |
| PER Floor | 54Mbps OFDM | 2.0 | | | % |
| | | | -80 | | |
| | | | 1.0 | 2.0 | % |

4.2.2. WLAN 2.4-GHz Transmitter Power

| Parameter | Condition | Min | Typ | Max | |
|---|---------------|------|-------|------|----------|
| Output Power - Maximum RMS output power measured at 1dB from IEEE spectral mask or EVM | 1 Mbps DSSS | 14.5 | 16.5 | - | dBm |
| | 2 Mbps DSSS | 14.5 | 16.5 | - | |
| | 5.5 Mbps CCK | 14.5 | 16.5 | - | |
| | 11 Mbps CCK | 14.5 | 16.5 | - | |
| | 6 Mbps OFDM | 14.5 | 16.5 | - | |
| | 9 Mbps OFDM | 14.5 | 16.5 | - | |
| | 12 Mbps OFDM | 14.5 | 16.5 | - | |
| | 18 Mbps OFDM | 14.5 | 16.5 | - | |
| | 24 Mbps OFDM | 13.5 | 15.7 | - | |
| | 36 Mbps OFDM | 12.6 | 14.8 | - | |
| | 48 Mbps OFDM | 11.9 | 14.1 | - | |
| | 54 Mbps OFDM | 11.3 | 13.3 | - | |
| | MCS0 MM | 13.4 | 15.6 | - | |
| | MCS1 MM | 13.4 | 15.6 | - | |
| | MCS2 MM | 13.4 | 15.6 | - | |
| | MCS3 MM | 13.4 | 15.6 | - | |
| | MCS4 MM | 12.8 | 14.8 | - | |
| | MCS5 MM | 11.9 | 14.1 | - | |
| | MCS6 MM | 11.3 | 13.3 | - | |
| | MCS7 MM | 10.1 | 12.1 | - | |
| | MCS0 MM 40MHz | 11.8 | 14.3 | - | |
| | MCS7 MM 40MHz | 9.7 | 11.7 | - | |
| Output power accuracy | | -1.5 | | +1.5 | dB |
| Output power resolution | | | 0.125 | | dB |
| Operation frequency range | | 2412 | | 2484 | MHz |
| Return loss | | | -10 | | dB |
| Reference input impedance | | | 50 | | Ω |

4.2.3. WLAN 5-GHz Receiver Characteristics

| Parameter | Condition | Min | Typ | Max | Units |
|---|------------------|------|-------|-------|-------|
| Operation frequency range | | 4910 | | 5825 | MHz |
| Sensitivity - 20MHz bandwidth. - At < 10% PER limit | 6 Mbps OFDM | - | -92.2 | -88.3 | dBm |
| | 9 Mbps OFDM | - | -90.4 | -86.4 | |
| | 12 Mbps OFDM | - | -89.6 | -85.6 | |
| | 18 Mbps OFDM | - | -87.1 | -83.1 | |
| | 24 Mbps OFDM | - | -84 | -80 | |
| | 36 Mbps OFDM | - | -80.6 | -76.6 | |
| | 48 Mbps OFDM | - | -76.3 | -72.3 | |
| | 54 Mbps OFDM | - | -74.7 | -71.2 | |
| | MCS0 MM 4K | - | -90.5 | -86.1 | |
| | MCS1 MM 4K | - | -87.7 | -83.7 | |
| | MCS2 MM 4K | - | -85.9 | -81.9 | |
| | MCS3 MM 4K | - | -82.8 | -78.8 | |
| | MCS4 MM 4K | - | -79.4 | -75.4 | |
| | MCS5 MM 4K | - | -75.1 | -71.1 | |
| | MCS6 MM 4K | - | -73.5 | -69.5 | |
| | MCS7 MM 4K | - | -72.2 | -68.6 | |
| | MCS0 MM 4K 40MHz | - | -87.7 | -82.5 | dBm |
| | MCS7 MM 4K 40MHz | - | -69 | -65.1 | |
| Max Input Level, At < 10% PER limit | OFDM(11a/n) | -27 | | | |
| Adjacent channel rejection Sensitivity level +3dB for OFDM | 54Mbps OFDM | 2 | | | dBm |
| LO Leakage | | | -53 | | dBm |
| PER Floor | | | 1.0 | 2.0 | % |

4.2.4. WLAN 5-GHz Transmitter Power

| Parameter | Condition | Min | Typ | Max | |
|---|---------------|------|-------|------|----------|
| Output Power - Maximum RMS output power measured at 1dB from IEEE spectral mask or EVM | 6 Mbps OFDM | 15.4 | 17.5 | - | dBm |
| | 9 Mbps OFDM | 15.4 | 17.5 | - | |
| | 12 Mbps OFDM | 15.4 | 17.5 | - | |
| | 18 Mbps OFDM | 15.4 | 17.5 | - | |
| | 24 Mbps OFDM | 14.8 | 16.4 | - | |
| | 36 Mbps OFDM | 14.1 | 15.7 | - | |
| | 48 Mbps OFDM | 13.3 | 14.9 | - | |
| | 54 Mbps OFDM | 12.3 | 14.1 | - | |
| | MCS0 MM | 15.1 | 17.1 | - | |
| | MCS1 MM | 15.1 | 17.1 | - | |
| | MCS2 MM | 15.1 | 17.1 | - | |
| | MCS3 MM | 15.1 | 17.1 | - | |
| | MCS4 MM | 13.9 | 15.7 | - | |
| | MCS5 MM | 13.3 | 14.9 | - | |
| | MCS6 MM | 12.3 | 14.1 | - | |
| | MCS7 MM | 11.4 | 13.1 | - | |
| | MCS0 MM 40MHz | 13.7 | 16.6 | - | |
| | MCS7 MM 40MHz | 10.4 | 12.3 | - | |
| Output power accuracy | | -1.5 | | +1.5 | dB |
| Output power resolution | | | 0.125 | | dB |
| Operation frequency range | | 4910 | | 5825 | MHz |
| Return loss | | | -10 | | dB |
| Reference input impedance | | | 50 | | Ω |

4.3. Bluetooth RF Performance

4.3.1. BT Receiver Characteristics, In-Band Signals

| Parameter | Condition | | Min | Typ | Max | BT Spec | Units |
|--|--|------|-------|-------|------|---------|----------|
| BT BR, EDR operation frequency range | | | 2402 | | 2480 | | MHz |
| BT BR, EDR channel spacing | | | | 1 | | | MHz |
| BT BR, EDR input impedance | | | | 50 | | | Ω |
| BT BR, EDR sensitivity ⁽¹⁾ Dirty TX on | BR, BER = 0.1% | | | -91.7 | | -70 | dBm |
| | EDR2, BER = 0.01% | | | -91.2 | | -70 | |
| | EDR3, BER = 0.01% | | | -84.2 | | -70 | |
| BT EDR BER floor at sensitivity + 10 dB, dirty TX off (for 1,600,000 bits) | EDR2 | | 1e-6 | | | 1e-5 | |
| | EDR3 | | 1e-6 | | | 1e-5 | |
| BT BR, EDR maximum useable input power | BR, BER = 0.1% | | -5.0 | | | -20 | dBm |
| | EDR2, BER = 0.1% | | -10.0 | | | -20 | |
| | EDR3, BER = 0.1% | | -10.0 | | | -20 | |
| BT BR intermodulation | Level of interferers For n = 3, 4, and 5 | | -36.0 | -30.0 | | -39 | dBm |
| BT BR, EDR C/I performance Numbers show wanted-signal to interfering-signal ratio. Smaller numbers indicate better C/I performances (Image frequency = -1MHz) | BR, Co-channel | | | 8.0 | | 11 | dB |
| | EDR, Co-channel | EDR2 | | 9.5 | | 13 | |
| | | EDR3 | | 16.5 | | 21 | |
| | BR, adjacent ± 1 MHz | | | -10.0 | | 0 | |
| | EDR, adjacent ± 1 MHz, (image) | EDR2 | | -10.0 | | 0 | |
| | | EDR3 | | -5.0 | | 5 | |
| | BR, adjacent +2 MHz | | | -38.0 | | -30 | |
| | EDR, adjacent +2 MHz, | EDR2 | | -38.0 | | -30 | |
| | | EDR3 | | -38.0 | | -25 | |
| | BR, adjacent -2 MHz | | | -28.0 | | -20 | |
| | EDR, adjacent -2 MHz | EDR2 | | -28.0 | | -20 | |
| | | EDR3 | | -22.0 | | -13 | |

| | | | | | | | |
|---------------------------|---------------------------------|------|--|-------|--|-----|----|
| | BR, adjacent $\geq \pm 31$ MHz | | | -45.0 | | -40 | |
| | EDR, adjacent $\geq \pm 31$ MHz | EDR2 | | -45.0 | | -40 | |
| | | EDR3 | | -44.0 | | -33 | |
| BT BR, EDR RF return loss | | | | -10.0 | | | dB |

(1) Sensitivity degradation up to -3dB may occur due to fast clock harmonics with dirty TX on.

4.3.2. BT Receiver Characteristics – General Blocking

| Parameter | Condition | Min | Typ | BT spec | Units |
|--|---------------|-----|-----|---------|-------|
| Blocking performance over full range, according to BT specification ⁽¹⁾ | 30-2000 MHz | -6 | | -10 | dBm |
| | 2000-2399 MHz | -6 | | -27 | |
| | 2484-3000 MHz | -6 | | -27 | |
| | 3-12.75 GHz | -6 | | -10 | |

1) Exceptions taken out of the total 24 allowed in the BT spec.

4.3.3. BT Receiver Characteristics – BR, EDR Blocking Per Band

| Parameter | Band | Min | Typ | Units |
|---|---|-----|-----|-------|
| Blocking performance for various cellular bands Hopping on. Wanted signal: -3dB from sensitivity, with modulated continuous blocking signal. BER = 0.1% for BT BR, 0.01% for BT EDR. PER = 1% | 776-794 MHz (CDMA) | | -12 | dBm |
| | 824-849 MHz (GMSK) ⁽¹⁾ | | -3 | |
| | 824-849 MHz (EDGE) ⁽¹⁾ | | -11 | |
| | 824-849 MHz (CDMA, QPSK) ⁽¹⁾ | | -12 | |
| | 880-915 MHz (GMSK) | | -14 | |
| | 880-915 MHz (EDGE) | | -15 | |
| | 1710-1785 MHz (GMSK) | | -4 | |
| | 1710-1785 MHz (EDGE) | | -18 | |
| | 1850-1910 MHz (GMSK) | | -18 | |
| | 1850-1910 MHz (EDGE) | | -20 | |
| | 1850-1910 MHz (CDMA, QPSK) | | -20 | |
| | 1850-1910 MHz (WCDMA, QPSK) | | -16 | |
| | 1920-1980 MHz (WCDMA, QPSK) | | -17 | |

1) Except for frequencies where [3 * F_BLOCKER] falls within the BT band (2400-2483.5 MHz)

4.3.4. BT Transmitter, BR

| Parameter | | Min | Typ | Max | BT Spec | Units |
|--|------------|-----|-------|-----|---------|-------|
| BR RF output power ⁽¹⁾ | VBAT >= 3V | | 12.2 | | | dBm |
| | VBAT < 3V | | 6.7 | | | |
| BR Gain Control Range | | | 30 | | | dB |
| BR Power Control Step | | 2 | 5 | 8 | 2 to 8 | |
| BR Adjacent Channel Power M-N = 2 ⁽²⁾ | | | -43.0 | | ≤ -20 | dBm |
| BR Adjacent Channel Power M-N > 2 ⁽²⁾ | | | -48.0 | | ≤ -40 | |

1) Values reflect maximum power. Reduced power is available using a vendor-specific (VS) command.

2) Assumes 3dB insertion loss on external filter and traces

4.3.5. BT Transmitter, EDR

| Parameter | | Min | Typ | Max | BT Spec | Units |
|---|------------|-----|-----|-----|----------|-------|
| EDR output power ⁽¹⁾ | VBAT >= 3V | | 6.7 | | | dBm |
| | VBAT < 3V | | 4.7 | | | |
| EDR relative power | | -2 | | 1 | -4 to +1 | dB |
| EDR Gain Control Range | | | 30 | | | dB |
| EDR Power Control Step | | 2 | 5 | 8 | 2 to 8 | dB |
| EDR Adjacent Channel Power M-N = 1 ⁽²⁾ | | | -36 | | ≤ -26 | dBc |
| EDR Adjacent Channel Power M-N = 2 ⁽²⁾ | | | -30 | | ≤ -20 | dBm |
| EDR Adjacent Channel Power M-N > 2 ⁽²⁾ | | | -42 | | ≤ -40 | |

1) Values reflect maximum power. Reduced power is available using a vendor-specific (VS) command.

2) Assumes 3dB insertion loss on external filter and traces.

4.3.6. BT Modulation, BR

| Parameter | Condition ⁽¹⁾ | Performances | | | BT spec | Units |
|-------------------------------|---|--|-----|-----|---------------|-------|
| | | Min | Typ | Max | | |
| BR -20dB Bandwidth | | | 925 | 995 | ≤1000 | kHz |
| BR modulation characteristics | Δf1avg | Mod data = 4-ones, 4-zeros: 111100001111... | | 160 | 140 to 175 | kHz |
| | Δf2max ≥ limit for at least 99.9% of all Δf2max | Mod data = 1010101... | | 130 | > 115 | kHz |
| | Δf2avg / Δf1avg | | | 88 | > 80 | % |
| BR carrier frequency | One slot packet | -25 | | +25 | < ±25 | kHz |

| | | | | | | |
|--|------------------------------|-----|--|----|-------|--------------|
| drift | Three and five slot packet | -35 | | 35 | < ±40 | kHz |
| BR drift rate | Ifk+5 – fkl , k = 0 max | | | 15 | < 20 | kHz/ 50µs |
| BR initial carrier frequency tolerance ⁽²⁾ | f0 – fTX | -25 | | 25 | < ±75 | kHz |

1) Performance figures at maximum power

2) This number is added on top of the reference clock frequency accuracy

4.3.7. BT Modulation, EDR

| Parameter ⁽¹⁾ | Condition | Min | Typ. | Max | BT spec | Units |
|--|-----------|-----|------|-----|---------|-------|
| EDR Carrier frequency stability | | -5 | | 5 | ≤10 | kHz |
| EDR Initial Carrier Frequency Tolerance ⁽²⁾ | | -25 | | 25 | ±75 | kHz |
| EDR RMS DEVM | EDR2 | | 4 | | 20 | % |
| | EDR3 | | 4 | | 13 | % |
| EDR 99% DEVM | EDR2 | | | 30 | 30 | % |
| | EDR3 | | | 20 | 20 | % |
| EDR Peak DEVM | EDR2 | | 9 | | 35 | % |
| | EDR3 | | 9 | | 25 | % |

1) Performance figures at maximum power

2) This number is added on top of the reference clock frequency accuracy

4.3.8. BT BR, EDR Transceiver - Emissions

| Parameter ⁽¹⁾ | Condition ⁽²⁾ | Performances | | | Units |
|----------------------------|-----------------------------|--------------|-----|------|-------|
| | | Min | Typ | Max | |
| BT out-of-band emission | 746-768 MHz (CDMA) | BR, EDR | | -151 | |
| | 869-894 MHz (WCDMA, GSM) | | | -149 | |
| | 925-960 MHz (E-GSM) | | | -148 | |
| | 1570-1580 MHz (GPS) | | | -145 | |
| | 1598-1607 MHz (GLONASS) (3) | | | -145 | |
| | 1805-1880 MHz (DCS, WCDMA) | | | -141 | |
| | 1930-1990 MHz (PCS) | | | -139 | |
| | 2110-2170 MHz (WCDMA) | | BR | -134 | |
| | | | | -129 | |
| BT harmonics | 2nd harmonic | | | 1.5 | |

| | | | | | |
|--|--------------|--|-----|--|-----|
| | 3rd harmonic | | -4 | | dBm |
| | 4th harmonic | | -10 | | dBm |

- 1) Meets FCC and ETSI requirements with suitable external filter
- 2) Performance figures at maximum power
- 3) Except for frequencies that corresponds to $2 \times \text{RF_FREQ}/3$

4.3.9. BT BR Transceiver - Spurs

| Parameter ⁽¹⁾ | Condition ⁽²⁾ | Performances | | | Units |
|--------------------------|-----------------------------|--------------|-----|-----|-------|
| | | Min | Typ | Max | |
| BT out-of-band spurs | 76-108 MHz (FM) | BR | -77 | | dBm |
| | 746-768 MHz (WCDMA) | | -79 | | dBm |
| | 869-894 MHz (WCDMA, GSM) | | -77 | | dBm |
| | 925-960 MHz (E-GSM) | | -77 | | dBm |
| | 1570-1580 MHz (GPS) | | -72 | | dBm |
| | 1598-1607 MHz (GLONASS) (3) | | -74 | | dBm |
| | 1805-1880 MHz (DCS, WCDMA) | | -72 | | dBm |
| | 1930-1990 MHz (PCS) | | -70 | | dBm |
| | 2110-2170 MHz (WCDMA) | | -59 | | dBm |

- 1) Meets FCC and ETSI requirements with suitable external filter
- 2) Performance figures at maximum power
- 3) Except for frequencies that corresponds to $2 \times \text{RF_FREQ}/3$

4.3.10. BT EDR Transceiver - Spurs

| Parameter | Condition ⁽¹⁾ | Performances | | | Units |
|----------------------|--|--------------|-----|-----|-------|
| | | Min | Typ | Max | |
| BT out-of-band spurs | 76-108 MHz (FM) | EDR | -82 | | dBm |
| | 746-768 MHz (WCDMA) | | -87 | | dBm |
| | 869-894 MHz (WCDMA, GSM) | | -85 | | dBm |
| | 925-960 MHz (E-GSM) | | -84 | | dBm |
| | 1570-1580 MHz (GPS) | | -79 | | dBm |
| | 1598-1607 MHz (GLONASS) ⁽²⁾ | | -78 | | dBm |
| | 1805-1880 MHz (DCS, WCDMA) | | -76 | | dBm |
| | 1930-1990 MHz (PCS) | | -74 | | dBm |
| | 2110-2170 MHz (WCDMA) | | -63 | | dBm |

- 1) Performance figures at maximum power
- 2) Except for frequencies that corresponds to $2 \times \text{RF_FREQ}/3$

4.4. BT LE RF Performance

4.4.1. BT LE Receiver Characteristics, In-Band Signals

| Parameter | Condition ⁽²⁾ | Min | Typ | Max | BLE spec | Units |
|--|---------------------------------------|------|-------|------|------------|----------|
| BT LE Operation frequency range | | 2402 | | 2480 | | MHz |
| BT LE Channel spacing | | | 2 | | | MHz |
| BT LE Input impedance | | | 50 | | | Ω |
| BT LE Sensitivity ⁽¹⁾ , Dirty Tx on | | | -92.8 | | ≤ -70 | dBm |
| BT LE Maximum useable input power | | -5 | | | ≥ -10 | dBm |
| BT LE Intermodulation characteristics | Level of interferers. For n = 3, 4, 5 | -36 | -30 | | ≥ -50 | dBm |
| BT LE C/I performance Note: Numbers show wanted signal-to-interfering signal ratio. Smaller numbers indicate better C/I performance. Image = -1MHz | LE, co-channel | | 8 | 12 | ≤ 21 | dB |
| | LE, adjacent ± 1 MHz | | -5 | 0 | ≤ 15 | |
| | LE, adjacent +2MHz | | -45 | -38 | ≤ -17 | |
| | LE, adjacent -2MHz | | -22 | -15 | ≤ -15 | |
| | LE, adjacent $\geq \pm 3 $ MHz | | -47 | -40 | ≤ -27 | |

1) Sensitivity degradation up to -3dB may occur due to fast clock harmonics.

2) BER of 0.1% corresponds to PER of 30.8% for a minimum of 1500 transmitted packets, according to BT LE test spec

4.4.2. BT LE Receiver Characteristics – General Blocking

| Parameter | Condition | Min | Typ | Max | BLE spec | Unit |
|--|--------------|-----|-----|-----|------------|------|
| BT LE Blocking performance over full range, according to LE specification ⁽¹⁾ | 30–2000MHz | -15 | | | ≥ -30 | dBm |
| | 2000–2399MHz | -15 | | | ≥ -35 | |
| | 2484–3000MHz | -15 | | | ≥ -35 | |
| | 3–12.75GHz | -15 | | | ≥ -30 | |

1) Exceptions taken out of the total 10 allowed for fbf_1, according to the BT LE Spec

4.4.3. BT LE Transmitter Characteristics

| Parameter | | Min | Typ | Max | BT LE Spec | Unit |
|---|------------|-----|-------|-----|------------|------|
| BT LE RF output power ⁽¹⁾ | Vbat >= 3V | | 12.2 | | ≤10 | dBm |
| | Vbat < 3V | | 6.7 | | ≤10 | dBm |
| BT LE Adjacent Channel Power M-N = 2 ⁽²⁾ | | | -51.0 | | ≤ -20 | dBm |
| BT LE Adjacent Channel Power M-N > 2 ⁽²⁾ | | | -54.0 | | ≤ -30 | |

1) To reduce the maximum BLE power, use a VS command. The optional extra margin is offered to compensate for design losses, such as trace and filter losses, and to achieve the maximum allowed output power at system level.

2) Assumes 3dB insertion loss on external filter and traces

4.4.4. BT LE Modulation Characteristics

| Parameter | Condition ⁽¹⁾ | Performances | | | BT Spec | Units |
|---|---|---|-----|-----|---------------|--------------|
| | | Min | Typ | Max | | |
| BT LE modulation characteristics | Δf1avg | Mod data = 4-ones, 4-zeros: 111100001111... | | 250 | 225 to 275 | kHz |
| | Δf2max ≥ limit for at least 99.9% of all Δf2max | Mod data = 1010101... | | 215 | ≥185 | kHz |
| | Δf2avg / Δf1avg | | 90 | | ≥80 | % |
| BT LE carrier frequency drift | I _{f0} – f _{nl} , n = 2,3 K | | -25 | 25 | ≤±50 | kHz |
| BT LE drift rate | I _{f1} – f _{0l} and I _{fn} – f _{n-5l} , n = 6,7.... K | | | 15 | ≤20 | kHz/ 50μs |
| LE initial carrier frequency tolerance ⁽²⁾ | f _n – f _{TX} | -25 | | 25 | ≤±100 | kHz |

1) Performance figures at maximum power

2) This number is added on top of the reference clock frequency accuracy

4.4.5. BT LE Transceiver – Emissions

See Section 4.3.8, BT BR, EDR Transceiver – Emissions.

4.4.6. BT LE Transceiver - Spurs

See Section 4.3.9, BT BR Transceiver – Spurs.

4.5. ANT Performance

4.5.1. ANT Receiver Characteristics, In-Band Signals

| Parameter | Condition | Min | Typ | Max | Units |
|-------------------------------|---------------------------|------|-------|------|-------|
| ANT Operation frequency range | | 2402 | | 2480 | MHz |
| ANT Channel spacing | | | 1 | | MHz |
| ANT Sensitivity | 12.72% PER ⁽¹⁾ | | -84.7 | | dBm |

- 1) Translation from BER=0.1%, assuming packet is 136 bits (not including preamble)

4.5.2. ANT Transmitter Characteristics

Same as Bluetooth BR Transmitter Characteristics

4.6. POWER CONSUMPTION

4.6.1. Shutdown and Sleep Currents

| Parameter | Power Supply Current | Typ | Unit |
|---|----------------------|-----|------|
| Shutdown mode (All functions shut down) | VBAT | 11 | uA |
| WLAN sleep mode | VBAT | 155 | |
| BT sleep mode | VBAT | 111 | |

4.6.2. WLAN Power Currents

| Parameter | Conditions | Typ (avg) - 25C | Units |
|-------------|-----------------------------------|-----------------|-------|
| LPM | 2.4GHz RX LPM | 48 | mA |
| Receiver | 2.4GHz RX search SISO20 | 53 | mA |
| | 2.4GHz RX search SISO40 | 58 | mA |
| | 5GHz RX search SISO20 | 59 | mA |
| | 5GHz RX search SISO40 | 63 | mA |
| | 2.4GHz RX 20M SISO 11CCK | 55 | mA |
| | 2.4GHz RX 20M SISO 6OFDM | 60 | mA |
| | 2.4GHz RX 20M SISO MCS7 | 64 | mA |
| | 2.4GHz RX 40MHz MCS7 | 76 | mA |
| | 5GHz RX 20MHz 6OFDM | 67 | mA |
| | 5GHz RX 20MHz MCS7 | 72 | mA |
| Transmitter | 5GHz RX 40MHz MCS7 | 84 | mA |
| | 2.4GHz TX 20M SISO 6OFDM 16.4dBm | 290 | mA |
| | 2.4GHz TX 20M SISO 11CCK 16.5dBm | 278 | mA |
| | 2.4GHz TX 20M SISO 54OFDM 13.1dBm | 252 | mA |
| | 2.4GHz TX 20M SISO MCS7 12.2dBm | 243 | mA |
| | 2.4GHz TX 40M SISO MCS7 11.8dBm | 248 | mA |
| | 5GHz TX 20M SISO 6OFDM 16.8dBm | 371 | mA |
| | 5GHz TX 20M SISO 54OFDM 13.4dBm | 334 | mA |
| | 5GHz TX 20M SISO MCS7 12.7dBm | 329 | mA |
| | 5GHz TX 40M SISO MCS7 11.9dBm | 337 | mA |

4.6.3. Bluetooth Currents

Current measurements are done at the following output power: BR at 12.5dBm, EDR at 7dBm.

| Use Case ⁽¹⁾ | Typ | Units |
|--|------|-------|
| BR Voice HV3 + sniff | 11.6 | mA |
| EDR Voice 2-EV3 no retrans. + sniff | 5.9 | mA |
| Sniff 1 attempt 1.28s | 178 | uA |
| EDR A2DP EDR2 (master). SBC high quality – 345Kbs | 10.4 | mA |
| EDR A2DP EDR2 (master). MP3 high quality – 192Kbs | 7.5 | mA |
| Full throughput ACL RX: RX-2DH5 ⁽²⁾⁽³⁾ | 18 | mA |
| Full throughput BR ACL TX: TX-DH5 ⁽³⁾ | 50 | mA |
| Full throughput EDR ACL TX: TX-2DH5 ⁽³⁾ | 33 | mA |
| Page or inquiry 1.28s/11.25ms | 253 | uA |
| P&I Scan (P=1.28/I=2.56) | 332 | uA |

1) BT role in all scenarios is Slave, except for A2DP

2) ACL RX has same current in all modulations

3) Full throughput assumed data transfer in one direction

4.6.4. Bluetooth LE Currents

All current measurements are done at output power of 8dBm

| Use Case | Typ | Units |
|---|-----|-------|
| Advertising, non-connectable ⁽¹⁾ | 131 | uA |
| Advertising, discoverable ⁽¹⁾ | 143 | uA |
| Scanning ⁽²⁾ | 266 | uA |
| Connected, master role, 1.28sec conn. Interval ⁽³⁾ | 124 | uA |
| Connected, slave role, 1.28sec conn. Interval ⁽³⁾ | 132 | uA |

1) Advertising in all 3 channels, 1.28sec advertising interval, 15 Bytes advertise data.

2) Listening to a single frequency per window, 1.28sec scan interval, 11.25msec scan window.

3) Zero Slave connection latency Empty Tx/Rx LL packets.

4.6.5. ANT Currents

| Use Case | Conditions | Typ | Units |
|---------------------|-----------------|-----|-------|
| ANT Rx message mode | 250ms interval | 360 | uA |
| ANT Rx message mode | 500ms interval | 220 | uA |
| ANT Rx message mode | 1000ms interval | 150 | uA |

5. HOST INTERFACE TIMING CHARACTERISTICS

The following table summarizes the Host Controller interface options. All interfaces operate independently.

| WLAN | Shared HCI for all functional blocks except WLAN | BT Voice/Audio |
|--------------|--|----------------|
| WLAN HS SDIO | Over UART | BT PCM |

The device incorporates UART module dedicated to the BT shared-transport Host Controller Interface (HCI) transport layer. The HCI interface is used to transport commands, events and ACL between the Bluetooth device and its host using HCI data packets. This acts as a shared transport for all functional blocks except WLAN.

5.1. WLAN SDIO Transport Layer

The SDIO is the host interface for WLAN. The interface between the host and the WG7835-T0 uses an SDIO interface and supports a maximum clock rate of 50MHz.

The Device SDIO also supports the following features of the SDIO V3 specification:

- 4 bit data bus
- Synchronous and Asynchronous In-Band-Interrupt
- Default and High-Speed (50MHz) timing
- Sleep/wake commands

5.2. SDIO Timing Specifications

5.2.1. SDIO Switching Characteristics – Default Rate

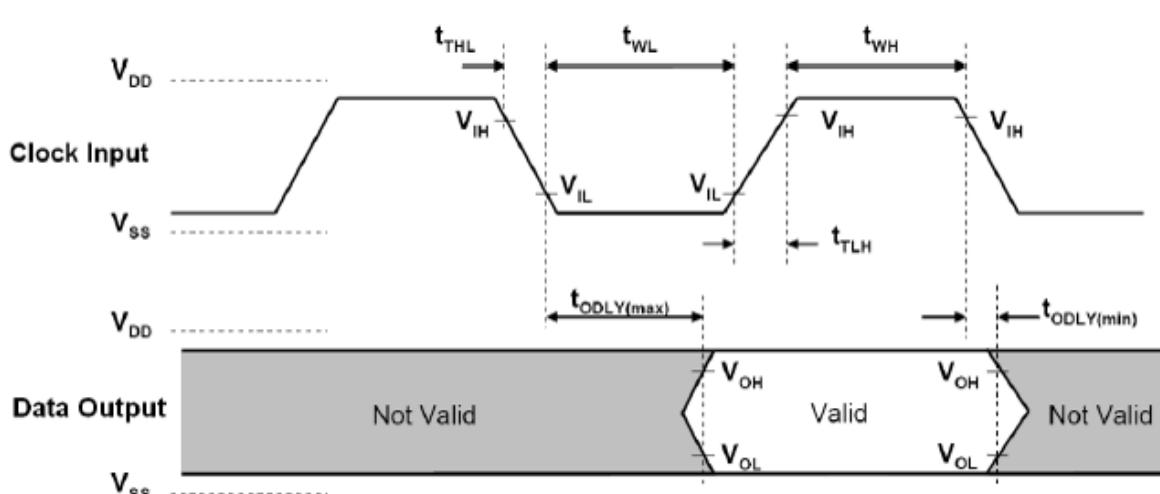
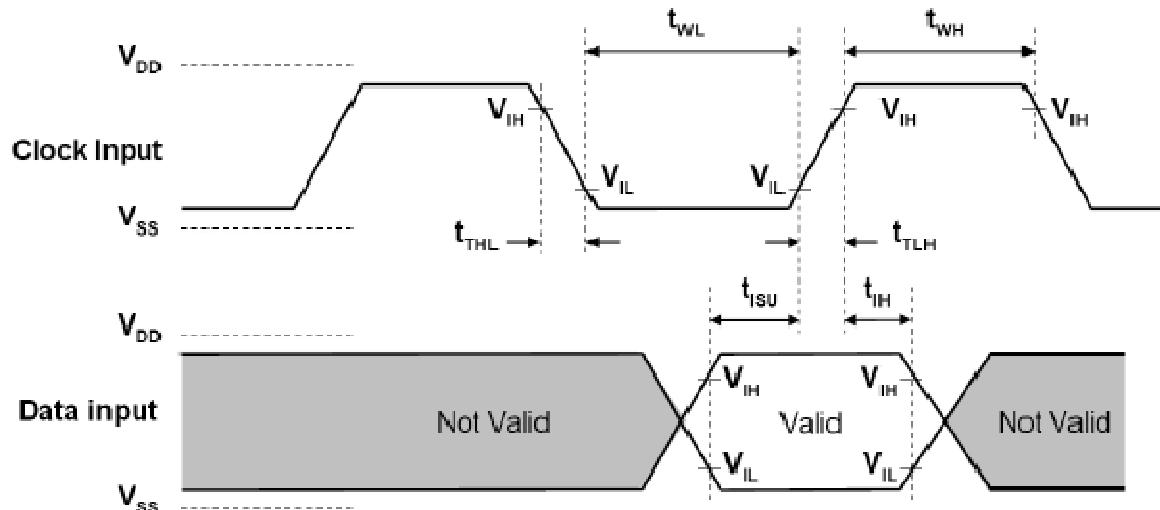


Table 5-1 SDIO Default Timing Characteristics⁽¹⁾

| PARAMETER ⁽²⁾ | | MIN | MAX | UNIT |
|--------------------------|----------------------|-----|-----|------|
| Fclock | Clock frequency, CLK | 0 | 26 | MHz |
| DC | Low/high duty cycle | 40 | 60 | % |
| tTLH | Rise time, CLK | | 10 | ns |
| tTHL | Fall time, CLK | | 10 | ns |

| | | | | |
|-------|-------------------------------------|-----|------|----|
| tISU | Setup time, input valid before CLK↑ | 3 | | ns |
| tIH | Hold time, input valid after CLK↑ | 2 | | ns |
| tODLY | Delay time, CLK↓ to output valid | 2.5 | 14.8 | ns |
| CI | Capacitive load on outputs | | 15 | pF |

- (1) To change the data out clock edge from the falling edge (default) to the rising edge, set the configuration bit.
(2) Parameter values reflect maximum clock frequency.

5.2.2. SDIO Switching Characteristics – High Rate

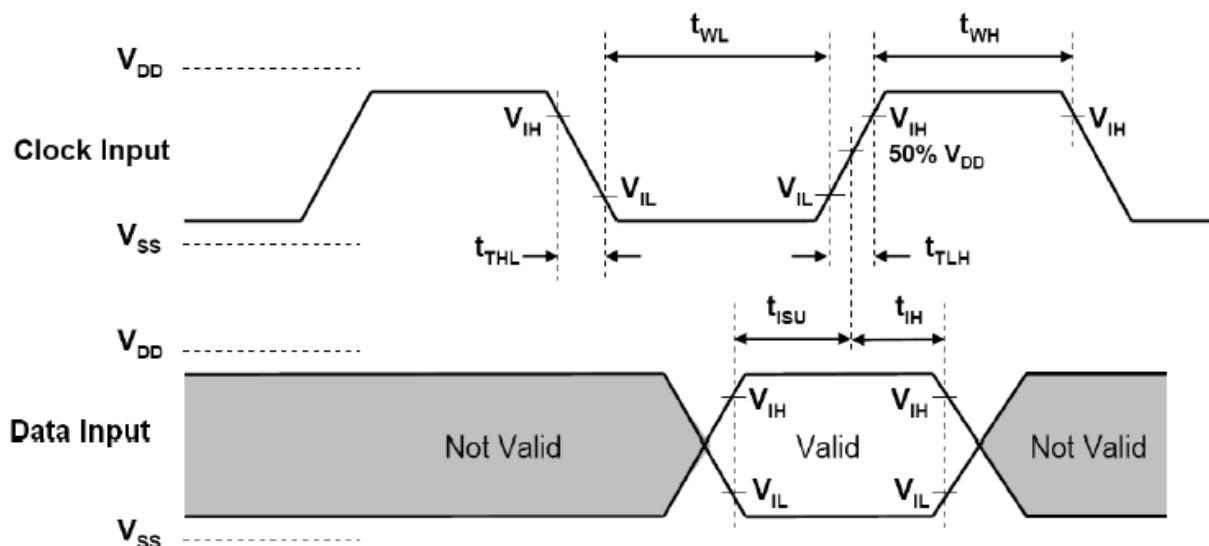


Figure 5-3. SDIO HS input timing

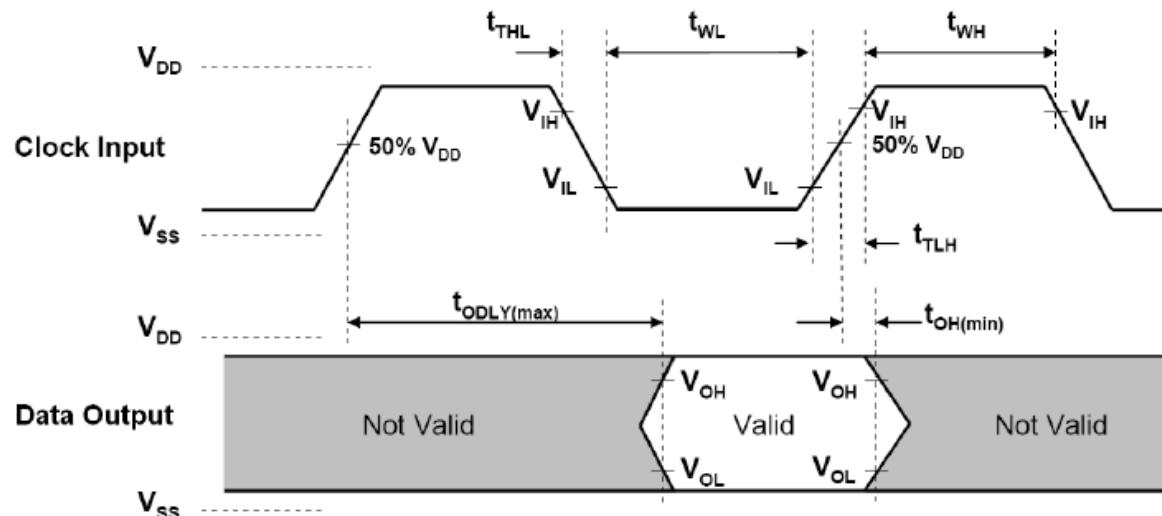


Figure 5-4 SDIO HS output timing

Table 5-2 SDIO HS Timing Characteristics

| PARAMETER | | MIN | MAX | UNIT |
|-----------|-------------------------------------|-----|-----|------|
| Fclock | Clock frequency, CLK | 0 | 50 | MHz |
| DC | Low/high duty cycle | 40 | 60 | % |
| tTLH | Rise time, CLK | | 3 | ns |
| tTHL | Fall time, CLK | | 3 | ns |
| tISU | Setup time, input valid before CLK↑ | 3 | | ns |
| tIH | Hold time, input valid after CLK↑ | 2 | | ns |
| tODLY | Delay time, CLK↓ to output valid | 2.5 | 14 | ns |
| CI | Capacitive load on outputs | | 10 | pF |

5.3. HCI UART Shared Transport Layers for All Functional Blocks (Except WLAN)

The HCI UART supports most baud rates (including all PC rates) for all fast clock frequencies - up to a maximum of 4 Mbps. After power up the baud rate is set for 115.2 kbps, regardless of fast clock frequency. The baud rate can then be changed by using a VS command. The Device responds with a Command Complete Event (still at 115.2 kbps), after which the baud rate change occurs.

HCI hardware includes the following features:

- Receiver detection of break, idle, framing, FIFO overflow and parity error conditions.
- Receiver Transmitter underflow detection.
- CTS/RTS hardware flow control.
- 4 wires (H4)

The below table lists the UART default settings

Table 5-3 UART Default Setting

| Parameter | Value |
|-------------|------------|
| Bit Rate | 115.2 kbps |
| Data Length | 8 bits |
| Stop Bit | 1 |
| Parity | None |

5.3.1. UART 4-Wires Interface – H4

The interface includes four signals: TXD, RXD, CTS and RTS. Flow control between the host and the Device is byte-wise by hardware. (See Figure 5-5)

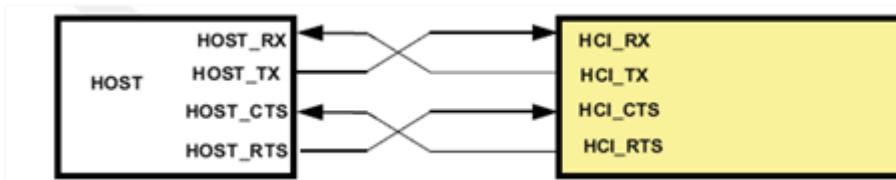


Figure 5-5 HCI UART Connection

When the UART RX buffer of the device passes the flow-control threshold, the buffer sets the UART_RTS signal high to stop transmission from the host. When the UART_CTS signal is set high, the device stops transmitting on the interface. If HCI_CTS is set high in the middle of transmitting a byte, the device finishes transmitting the byte and stops the transmission.

5.4. UART Timing Specifications

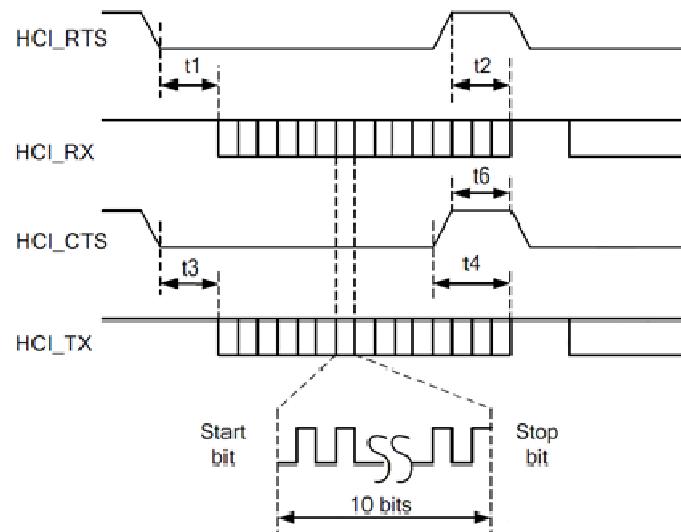
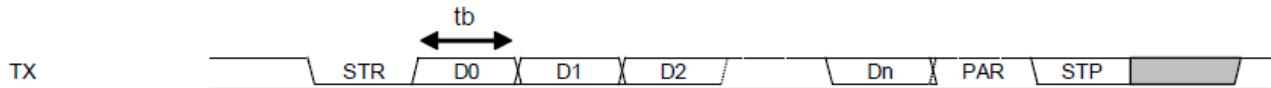


Figure 5-6 UART Timing Diagram

Table 5-4 UART Timing Characteristics

| Characteristic | Condition | Symbol | Min | Typ | Max | Unit |
|-----------------------------|-----------|--------|-------|-----|-------|------|
| Baud rate | | | 37.5 | | 4364 | Kbps |
| Baud rate accuracy per byte | RX/TX | | -2.5 | | +1.5 | % |
| Baud rate accuracy per bit | RX/TX | | -12.5 | | +12.5 | % |
| CTS low to TX_DATA on | | t3 | 0 | 2 | | us |

| | | | | | | |
|-------------------------|---------------------------|----|---|---|----|-------|
| CTS low to TX_DATA off | Hardware flow control | t4 | | | 1 | Byte |
| CTS High Pulse Width | | t6 | 1 | | | bit |
| RTS low to RX_DATA on | | t1 | 0 | 2 | | us |
| RTS high to RX_DATA off | Interrupt set to 1/4 FIFO | t2 | | | 16 | Bytes |



STR-Start bit; D0..Dn - Data bits (LSB first); PAR - Parity bit (if used); STP - Stop bit

Figure 5-7 UART Data Frame

5.5. Bluetooth Codec-PCM(Audio) Timing Specifications

Figure 5-8 shows the Bluetooth codec-PCM (audio) timing diagram.

Table 5-5 lists the Bluetooth codec-PCM master timing characteristics.

Table 5-6 lists the Bluetooth codec-PCM slave timing characteristics.

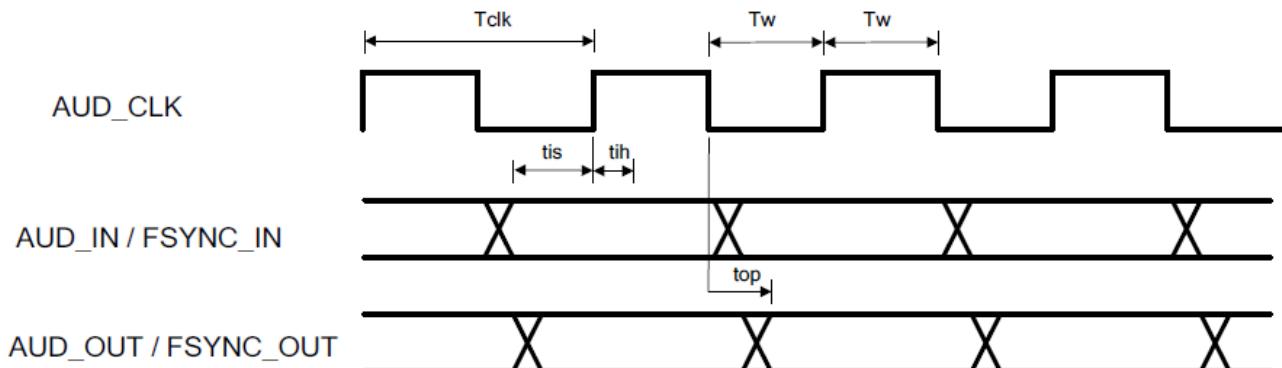


Figure 5-8. PCM Interface Timing

Table 5-5 Bluetooth Codec-PCM Master Timing Characteristics

| Parameter | Symbol | Min | Max | Unit |
|--------------------------------|--------|-------------------|----------------|------|
| Cycle time | Tclk | 166.67 (6.144MHz) | 15625 (64 kHz) | ns |
| High or low pulse width | Tw | 35% of Tclk min | | |
| AUD_IN setup time | tis | 10.6 | | |
| AUD_IN hold time | tih | 0 | | |
| AUD_OUT propagation time | top | 0 | 15 | |
| AUD_FSYNC_OUT propagation time | top | 0 | 15 | |
| Capacitive loading on outputs | Cl | | 40 | |
| | | | | pF |

Table 5-6 Bluetooth Codec-PCM Slave Timing Characteristics

| Parameter | Symbol | Min | Max | Unit |
|--------------------------------|--------|-----------------|-----|------|
| Cycle time | Tclk | 81 (12.288MHz) | | ns |
| High or low pulse width | Tw | 35% of Tclk min | | |
| AUD_IN setup time | tis | 5 | | |
| AUD_IN hold time | tih | 0 | | |
| AUD_OUT propagation time | top | 5 | | |
| AUD_FSYNC_OUT propagation time | top | 0 | 19 | |
| Capacitive loading on outputs | Cl | | 40 | pF |

6. CLOCK AND POWER MANAGEMENT

The slow clock is a free-running, 32.768 kHz clock supplied from an external clock source. The clock is connected to the RTC_CLK pin and is a digital square-wave signal in the range of 0 to 3.3V nominal

6.1. Reset-Power-Up System

After VBAT is fed to the device and while BT_EN and WL_EN are deasserted (low), the device is in SHUTDOWN state, during which functional blocks, internal DC-DCs, and LDOs are disabled. The power supplied to the functional blocks is cut off. When one of the signals (BT_EN or WL_EN) are asserted (high), a power-on reset (POR) is performed. Stable slow clock and VBAT are prerequisites for a successful POR.

6.2. WLAN Power-Up Sequence

Figure 6-1 shows the WLAN power-up sequence.

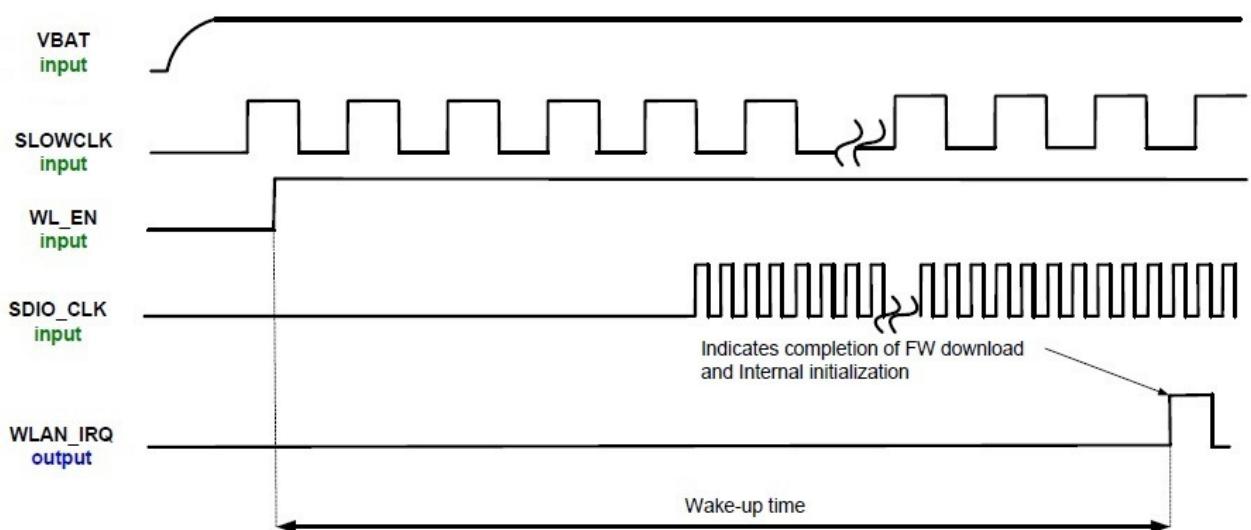


Figure 6-1 WLAN Power-Up Sequence

6.3. Bluetooth/BLE/ANT Power-Up Sequence

Figure 6-2 shows the Bluetooth/BLE/ANT power-up sequence.

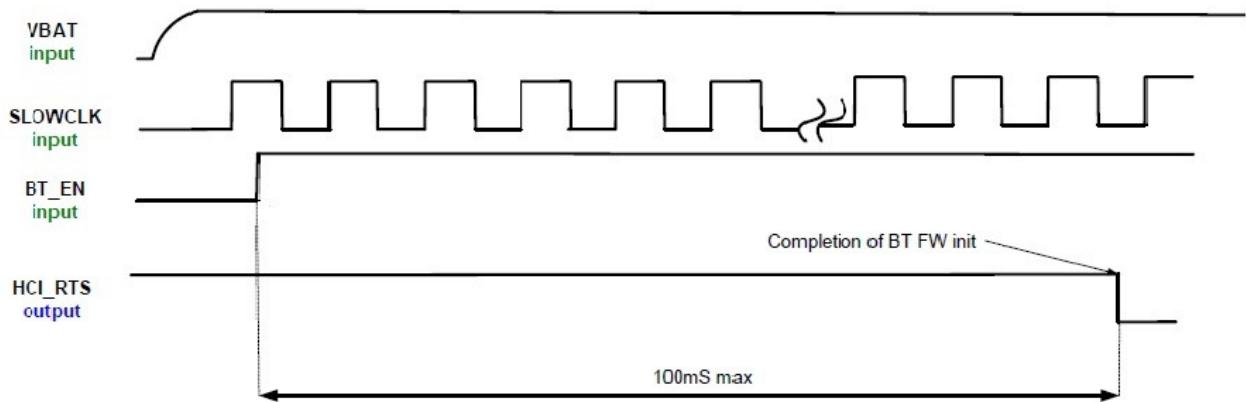


Figure 6-2 Bluetooth/BLE/ANT power-up sequence

7. REFERENCE SCHEMATIC

7.1. Module Reference Design

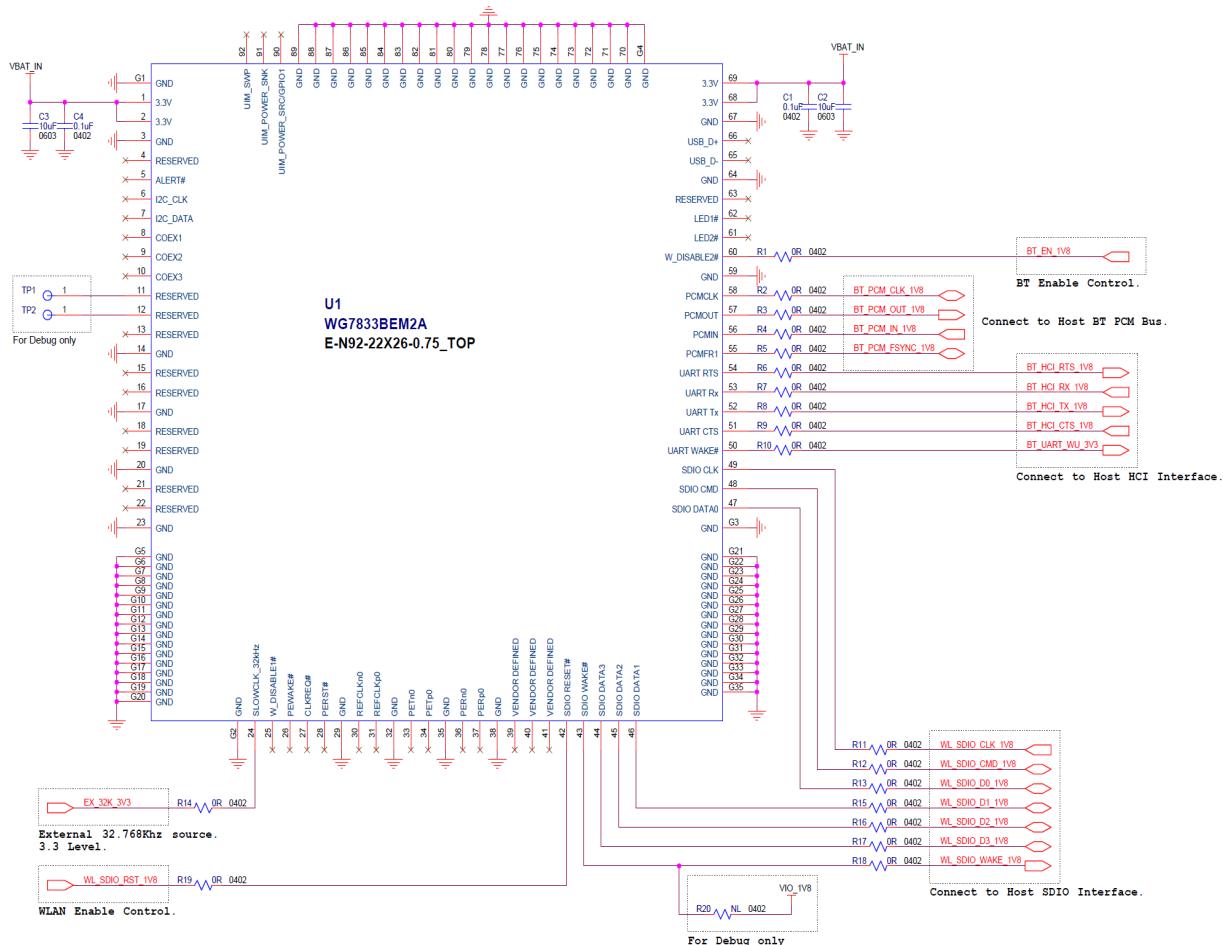


Figure 7-1 Module Reference Schematic

8. DESIGN RECOMMENDATIONS

8.1. Design Note on Debug Port

- Pin# 11, 12 serve as WLAN and BT debug port, respectively. So test points for these two signals should be reserved for debugging purpose.
- Pin# 43 (SDIO WAKE#) needs to be pulled high via 10Kohm and use Pin# 11, 12 as hardware interface to communicate with system platform and TI RTTT test utility for WLAN RF performance test, debug and manufacturing application.

8.2. Module Layout Recommendations

Follow these module layout recommendations:

- Digital Signals Layout
 - SDIO signals traces (CMD, D0, D1, D2 and D3) should be routed in parallel to each other and as short as possible. (**Less than 12cm**) Besides, every trace length must be the same as the others.
 - Enough space above 1.5 time trace width or ground shielding between trace and trace will be benefit to make sure signal quality, especially for SDIO_CLK trace. Remember to keep them away from the other digital or analog signal traces. Adding ground shielding around these bus is recommended.
 - Route trace of SDIO_CLK at Top layer without vias.
 - SDIO Clock, Audio Clock (PCM_AUD_CLK), these digital clock signals are a source of noise. Keep the traces of these signals as short as possible. Whenever possible, maintain a clearance around them.
 - BT_AUD signals should be rounted in the same group and it's better to rout them at the same layer or confirm them referring to the same reference plane.
- Power Trace
 - Power trace for VBAT should be 20mil wide, at least.
 - Isolate different power traces with Ground plane
- Ground
 - Having a complete Ground and more GND vias under module in layer1 for system stable and thermal dissipation.
 - Have a complete Ground pour in layer 2 for thermal dissipation.

- Increase the GND pour in the 1st layer, move all the traces from the 1st layer to the inner layers if possible.
 - Move GND vias close to the pad.
- Clocks
- It is preferable to keep all clocks between the ground/power layers.

9. PACKAGE INFORMATION

9.1. NGFF Type 2226 Specification from PCI-e M.2_Rev1.0

※ Only Ant1 and Ant2 on this module.

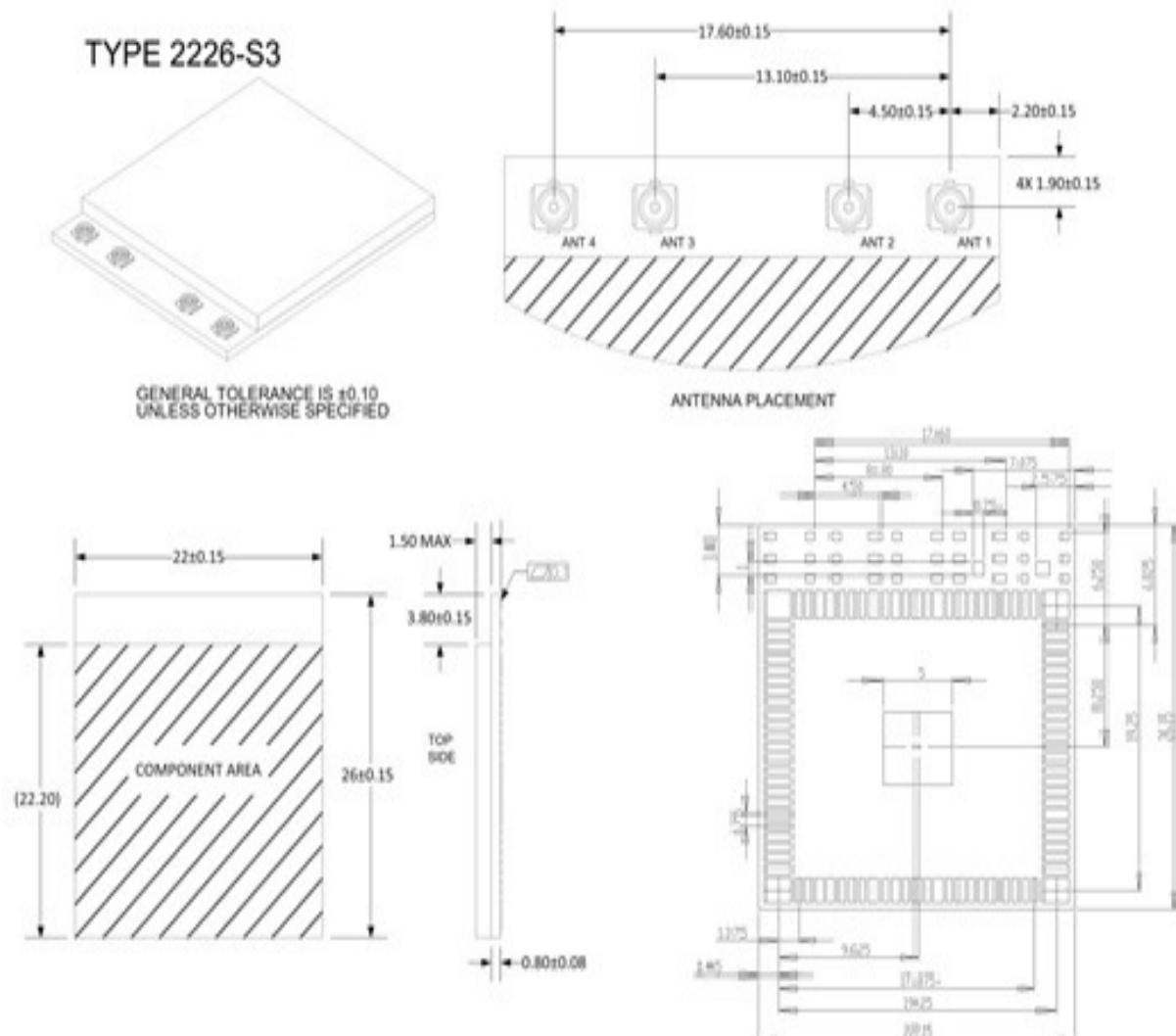


Figure 9-1 M.2 Type 2226-S3 Mechanical Outline Drawing

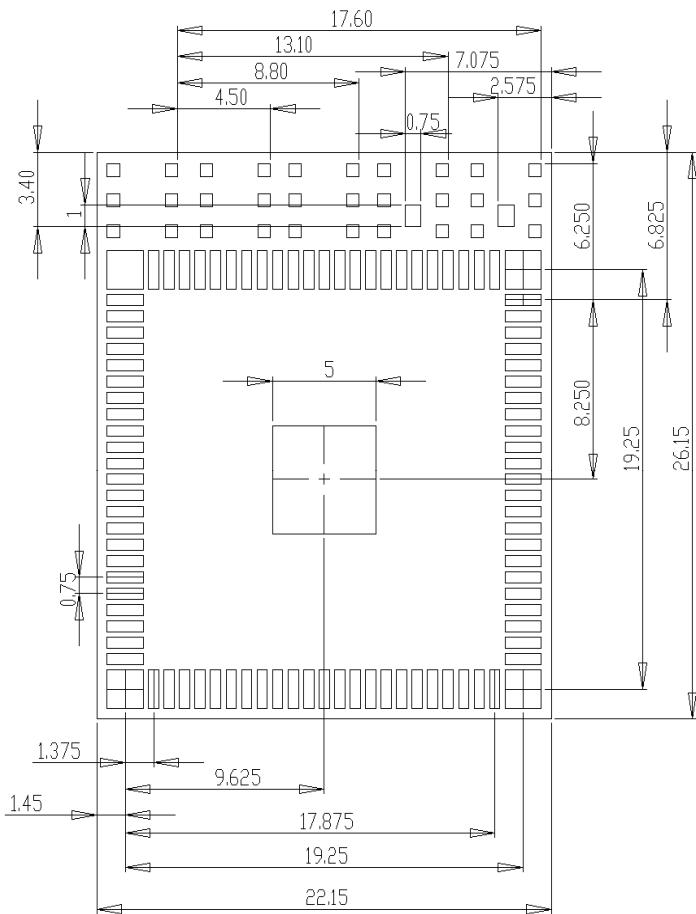


Figure 9-2 Recommended Land Pattern for Module Type 2226

9.2. WG7833BEM2A Module Drawing

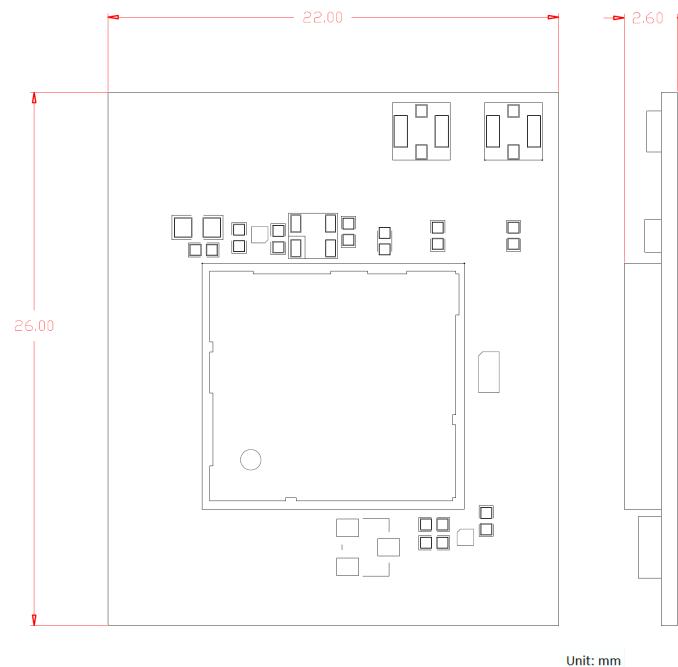
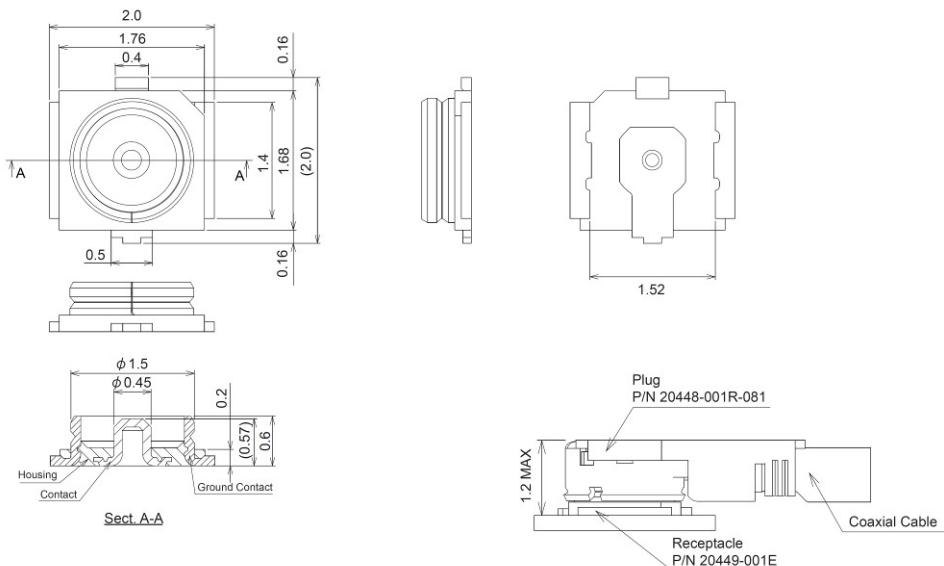


Figure 9-3 Module drawing

9.3. RF Connector



※ P/N : 20449-001E (MHF4 series) from I-PEX

Figure 9-4 RF Connect drawing

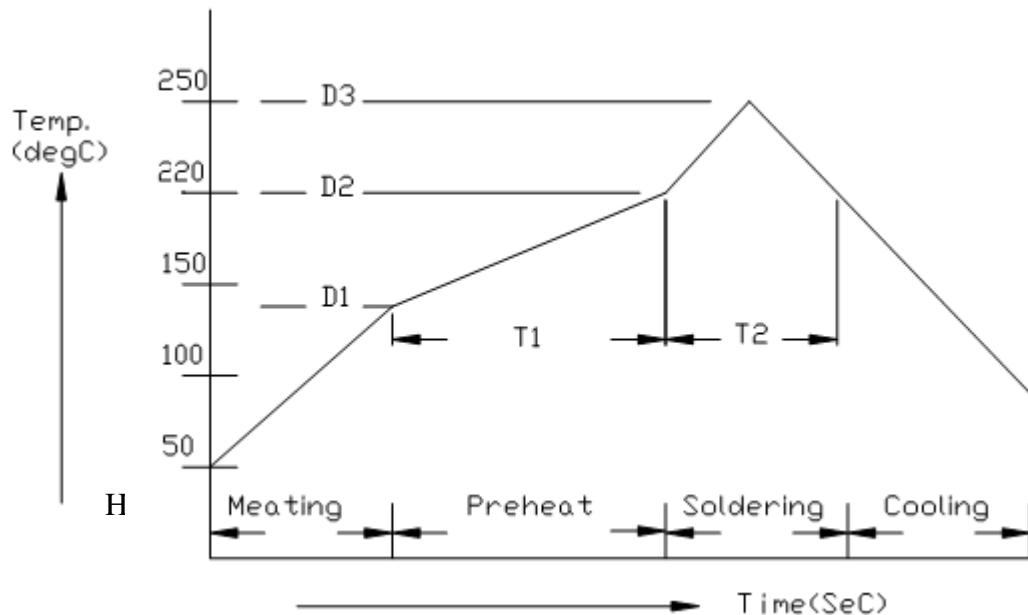
10. SMT AND BAKING RECOMMENDATION

10.1. Baking Recommendation

- Baking condition :
 - Follow MSL Level 4 to do baking process.
 - After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be
 - a) Mounted within 72 hours of factory conditions <30°C/60% RH, or
 - b) Stored at <10% RH.
 - Devices require bake, before mounting, if Humidity Indicator Card reads >10%
- If baking is required, Devices may be baked for 8 hrs. at 125 °C.

10.2. SMT Recommendation

- Recommended Reflow profile :



| No. | Item | Temperature | Heating Time |
|-----|------------|-----------------|-------------------|
| 1 | Pre-heat | D1 = 140 °C | T1: 80 ~ 120 sec |
| 2 | Soldering | D2 = 220 °C | T2: 60 +/- 10 sec |
| 3 | Peak-Temp. | D3 = 250 °C max | |

Note: (1) Reflow soldering is recommended two times maximum.

(2) Add Nitrogen while Reflow process : SMT solder ability will be better.

- **Stencil thickness :** 0.1~ 0.13 mm (Recommended)
- **Soldering paste (without Pb) :** Recommended SENJU N705-GRN3360-K2-V can get better soldering effects.

11. HISTORY CHANGE

| Revision | Date | Description |
|----------|----------------|------------------------------|
| D 0.1 | 2015 / 02 / 26 | New Released |
| D 0.2 | 2015 / 07 / 28 | Add FCC/NCC WARING STATEMENT |
| | | |

FCC WARING STATEMENT

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

You are cautioned that changes or modifications not expressly approved by the party responsible for compliance could void your authority to operate the equipment.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference and (2) this device must accept any interference received, including interference that may cause undesired operation.

FCC RF Radiation Exposure Statement:

1. This Transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.
2. This equipment complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with a minimum distance of 20 centimeters between the radiator and your body.

According to FCC 15.407(e), the device is intended to operate in the frequency band of 5.15GHz to 5.25GHz under all conditions of normal operation. Normal operation of this device is restricted to indoor used only to reduce any potential for harmful interference to co-channel MSS operations.

Information to OEM integrator

The OEM integrator has to be aware not to provide information to the end user regarding how to

install or remove this RF module in the user manual of the end product. The user manual which is provided by OEM integrators for end users must include the following information in a prominent location.

1. To comply with FCC RF exposure compliance requirements, the antenna used for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter, except in accordance with FCC multi-transmitter product transmitter product procedures.
2. Only those antennas with same type and lesser gain filed under this FCC ID number can be used with this device.
3. The regulatory label on the final system must include the statement: “Contains **FCC ID: WS2-WG7833B0**”.
4. The final system integrator must ensure there is no instruction provided in the user manual or customer documentation indicating how to install or remove the transmitter module except such device has implemented two-ways authentication between module and the host system.
5. If the end product integrating this module is going to be operated in 5.15 ~5.25GHz frequency range, the warning statement in the user manual of the end product should include the restriction of operating this device in indoor could void the user's authority to operate the equipment.

NCC WARING STATEMENT

Article 12

Without permission, any company, firm or user shall not alter the frequency, increase the power, or change the characteristics and functions of the original design of the certified lower power frequency electric machinery.

Article 14

The application of low power frequency electric machineries shall not affect the navigation safety nor interfere a legal communication, if an interference is found, the service will be suspended until improvement is made and the interference no longer exists.